

(3,81 mm) .150"

DUAL LEAF 20 A POWER SOCKET

SPECIFICATIONS

For complete specifications see www.samtec.com?UPS

Insulator Material: Black LCP Contact Material: BeCu Plating: Sn or Au over 50µ"

(1,27 µm) Ni

Operating Temp Range:
-55°C to +105°C with Tin;
-55°C to +125°C with Gold

Voltage Rating: 375 VAC/530 VDC RoHS Compliant: Yes

Lead-Free Solderable: Yes (-V, -RA options)

RECOGNITIONS

For complete scope of recognitions see www.samtec.com/quality



ALSO AVAILABLE (MOQ Required)

 Solder leads for (2,36 mm) .093" thick board

Contact Samtec.

TOOLING

Press fit tooling available.
Contact Samtec.

MATED HEIGHT*		
UPS LEAD STYLE	UPT LEAD STYLE	
	-03.0	
-04.0	(7,00) .276	
-07.0	(10,00) .394	

*Processing conditions will affect mated height.

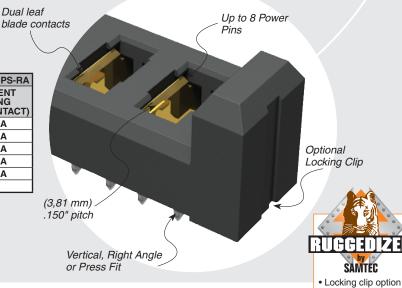
Note: Some sizes, styles and options are non-standard, non-returnable.



UPT-V/UPS-V		UPT-RA/UPS-RA		
PINS		CURRENT RATING (PER CONTACT)		
1	23 A	23.5 A		
2	18.6 A	20.1 A		
3	17.5 A	16.9 A		
4	16.7 A	15.5 A		
ALL	14 A	13.3 A		
	-L PLATING			

POWER

PINS



-02, -04, -06, -08

UPS

LEAD STYLE	Α	В
-04.0	(3,75) .148	(6,75) .266
-07.0	(6,75) .266	(9,75) .384

-01 = RA only

LEAD

STYLE

-04.0 = (04,0 mm) .157" (-V & -PV only)

-07.0 = (07,0 mm) .276" (-V & -PV only)

TAIL LENGTH

-01 = Use with (1,60 mm) .062" Thick PCB (-V & -RA only)

-03 = Use with (1,60 mm) .062' Thick PCB (-PV only)

PLATING OPTION

—__ = 10μ" (0,25 μm) Gold on contact, Matte Tin

-T = Matte Tin (-RA option only)

on tail

—V = Vertical (Not available with –T plating)

TAIL

-RA = Right Angle

-PV = Press Fit, Vertical

-LC = Locking Clip (Manual placement required) Not available with -PV option

OTHER

OPTION

